Half-mount type with 0.85mm installed height above the PC board





■ Typical Specifications

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10μA 1V DC
Initial contact resistance	500mΩ max.
Travel (mm)	0.15
Protective structure **	IP67 equivalent

■ Product Line

Product No. Operating force		Operating direction	Operating life	Minimum order unit (pcs.)	
T TOUGET NO.	Operating force	Operating direction	(5mA 5V DC)	Japan	Export
SKTGLBE010	1.6N	Side push	200,000 cycles	5,500	5,500

■ Packing Specifications

Taping

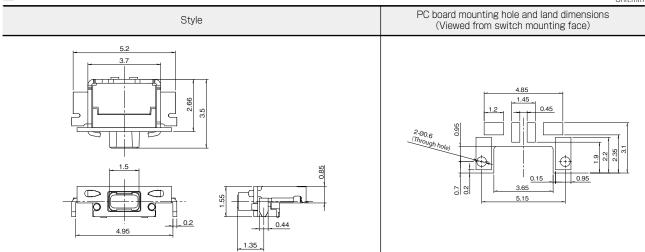
Number of packages (pcs.)			Tape width	Export package
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
5,500	55,000	55,000	12	395×395×205

Unit:mm Reel size

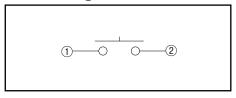
Note

For reels of 330mm diameter, please inquire.

Dimensions



■ Circuit Diagram



* Assumes the switch is left alone without being operated. Under the specified conditions, dust and water ingress with a significant impact on the switch's on-off function is prevented.

IP67 dust and water resistance is guaranteed for the switch alone and performance may not be guaranteed depending on the mounting conditions and usage.

Type					Sharp Fe	eling Type			
	туре				Surfac	e Mount			
	Series	SKST	SKRA	SKHM	SKHU	SKTD	SKSN	SKTG	SKSL
	Photo								0,4
	Features	Middle	e travel	_	_	Low-profile	Mid-mount	Half-n	nount
	Water-proof	_	0	_	0	•	_	•	_
	Dust-proof	_	0	_	0	•	_	•	_
	IP standard	_	67 equivalent	_	_	67 equivalent	_	67 equivalent	_
Operatir	Top push	•	•	•	•	_	_	_	_
directio		_	_	_	_	•	•	•	•
	W			6.2	6.2	3.9	6.2	5.2	4.5
Dimensio (mm)		□8.5	□6.2	6.5	6.3	2.9	3	3.5	2.6
(111111)	Н	3.95	3.5/5.2	3.1	2.5/3.1	1.55	3.5	1.55	2.2
Operation force coverage	2N to 3N	4N to 10N			1	‡		\$	1
	Travel (mm)	0.9	See the relevant pages for respective product description	0	.25	0.15	0.2	0.	15
G	round terminal	_		•	•	•	•	•	•
Operatin	ng temperature range	-40°C 1	to +90℃	-40℃	to +85℃	−30°C to +85°C	-40℃ to +85℃	-30°C t	o +85℃
А	utomotive use	•	0	_	0	_	_	_	_
	Life Cycle	* 2	*3	*3	*3	*2	* 2	*2	* 2
	Rating (max.) (Resistive load)	50mA 16V DC				50mA 12V DC)		
Electrical	Rating (min.) (Resistive load)				10μΑ	V 1V DC			
performance	Insulation resistance				100MΩ min.	100V DC 1min.			
	Voltage proof		250V A	C 1min.		100V AC 1min.	250V A	C 1min.	100V AC 1min.
	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively							
Durability	Lifetime	Shall be in accordance with individual specifications.							
	Cold	-40°C 1,000h		-40°C 96h					
Environmental performance	Dry heat	90°C	1,000h	90°C 96h		85℃ 96h	90℃ 96h	85℃ 96h	90°C 96h
	Damp heat	60°C, 90 to 95%RH 1,000h 60°C, 90 to 95%RH 96h			I				
	Page	230	231	232	233	235	236	237	238

W : Width. The most outer dimension excluding terminal portion. D : Depth. The most outer dimension excluding terminal portion.

 $\ensuremath{\mathsf{H}}$: Height. The minimum dimension if there are variances.

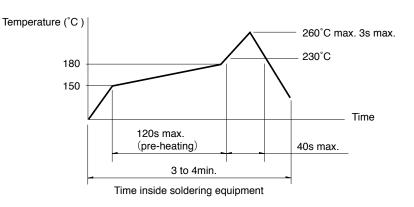
TACT Switch™ Soldering Conditions · · · · · · · · · · · · · · · · · · ·
TACT Switch TM Cautions · · · · · · · · · · · · · · · · · · ·

Notes

- 1. The automotive operating temperature range to be individually discussed upon request.
- 2. lacktriangle Indicates applicability to all products in the series, while \bigcirc indicates applicability to some products in the series.

TACT Switch™ / Soldering Conditions

Condition for Reflow Available for Surface Mount Type. Temperature profile



Notes

- 1. Please confirm the specifications of our product for the detailed condition.
- Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

■ Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHL Top Push Type, SKQJ Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

■ Manual Soldering

Items	Condition
Soldering temperature	350℃ max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH, SKHW Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Notes

- 1. Prevent flux penetration from the top side of the TACT Switch™.
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA CORPORATION, or equivalents.)

